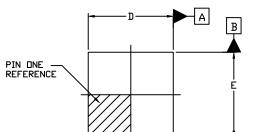


DATE 21 MAY 2019



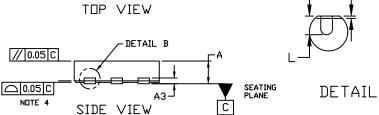
NOTES:

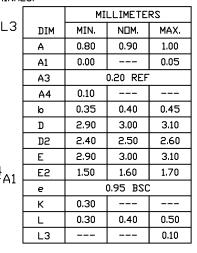
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS

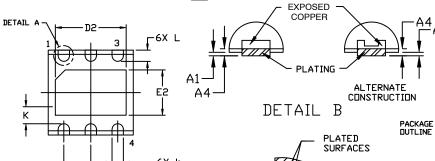
ALTERNATE

CONSTRUCTION

- DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
- COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.







0.10 C A B

0.05 C NOTE 3

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PLATED SURFACES

3

L3

SECTION C-C

0.25 0.95 6X 0.60 1.40 0.25 0.40

RECOMMENDED MOUNTING FOOTPRINT

For additional information on ur Pb-Free strategy and soldering details, please download the DN Seniconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

XXXXX = Specific Device Code A = Assembly Location

B□TT□M VIEW **GENERIC**

MARKING DIAGRAM*

XXXXX

XXXXX

ALYW=

A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
= Pb-Free Package

^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	DFNW6 3X3, 0.95P		PAGE 1 OF 1

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